NSZ5V6V2T1G

Zener Voltage Regulators

200 mW SOD-523 Surface Mount

This series of Zener diodes is packaged in a SOD-523 surface mount package. They are designed to provide voltage regulation protection and are especially attractive in situations where space is at a premium. They are well suited for applications such as cellular phones, hand held portables, and high density PC boards.

Specification Features

- Standard Zener Breakdown Voltage of 5.6 V
- Steady State Power Rating of 200 mW
- Small Body Outline Dimensions: 0.047" x 0.032" (1.20 mm x 0.80 mm)
- Low Body Height: 0.028" (0.7 mm)
- ESD Rating of Class 3 (>16 kV) per Human Body Model
- Tight Tolerance V_Z
- These are Pb-Free Devices

Mechanical Characteristics

CASE: Void-free, transfer-molded, thermosetting plastic

Epoxy Meets UL 94, V-0

LEAD FINISH: 100% Matte Sn (Tin)

MOUNTING POSITION: Any

QUALIFIED MAX REFLOW TEMPERATURE: 260°C

Device Meets MSL 1 Requirements

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (Note 1) @ T _A = 25°C Derate above 25°C	P _D	200 1.5	mW mW/°C
Thermal Resistance from Junction-to-Ambient	$R_{\theta JA}$	635	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-65 to +150	°C

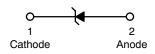
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-4 Minimum Pad.



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SOD-523 CASE 502 PLASTIC

MARKING DIAGRAM



CT = Specific Device Code

M Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
NSZ5V6V2T1G	SOD-523*	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*This package is inherently Pb-Free.

DEVICE MARKING INFORMATION

See specific marking information in the device marking column of the Electrical Characteristics table on page 2 of this data sheet.

NSZ5V6V2T1G

ELECTRICAL CHARACTERISTICS

 $(T_A = 25^{\circ}C \text{ unless otherwise noted},$

 $V_F = 0.9 \text{ V Max.} @ I_F = 10 \text{ mA for all types})$

Symbol	Parameter					
V _Z	Reverse Zener Voltage @ I _{ZT}					
I _{ZT}	Reverse Current					
Z _{ZT}	Maximum Zener Impedance @ I _{ZT}					
I _{ZK}	ZK Reverse Current					
Z _{ZK}	ZK Maximum Zener Impedance @ I _{ZK}					
I _R	Reverse Leakage Current @ V _R					
V _R	Reverse Voltage					
IF	Forward Current					
V _F	Forward Voltage @ I _F					
ΘV_Z	Maximum Temperature Coefficient of V _Z					
С	Max. Capacitance @V _R = 0 and f = 1 MHz					

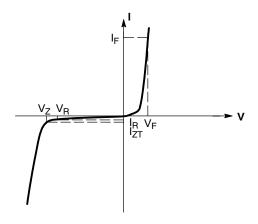


Figure 1. Zener Voltage Regulator

ELECTRICAL CHARACTERISTICS ($V_F = 0.9 \text{ Max} @ I_F = 10 \text{ mA}$ for all types)

	Test	V//		7 ^{2ZK Z} ^{Z - Z}			d _{VZ} /dt (mV/k) @ I _{ZT1} = 5 mA		C pF Max @ V _R	
Device*	Current Izt mA	Min	Max	mA Ω Max	Mod Ω Max	μА	v	Min	Max	= 0 f = 1 MHz
NSZ5V6V2T1G	5.0	5.49	5.73	200	40	1.0	2.0	-2.0	2.5	200

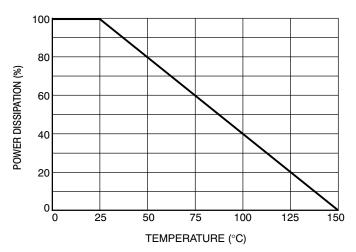
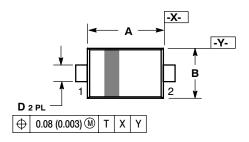


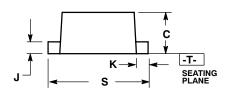
Figure 2. Steady State Power Derating

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PACKAGE DIMENSIONS

SOD-523 CASE 502-01 ISSUE C



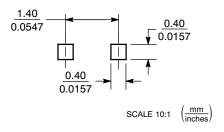


NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
 VIA EM 1082
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAI

	MI	LLIMETE	RS	INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	1.10	1.20	1.30	0.043	0.047	0.051	
В	0.70	0.80	0.90	0.028	0.032	0.035	
С	0.50	0.60	0.70	0.020	0.024	0.028	
D	0.25	0.30	0.35	0.010	0.012	0.014	
J	0.07	0.14	0.20	0.0028	0.0055	0.0079	
K	0.15	0.20	0.25	0.006	0.008	0.010	
S	1.50	1.60	1.70	0.059	0.063	0.067	

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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